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(5-2008)



Vishay BCcomponents

Enhanced Leadless NTC Thermistor Die Suitable for Wire Bonding



LINKS TO ADDITIONAL RESOURCES



QUICK REFERENCE DATA					
PARAMETER	VALUE	UNIT			
Resistance value at 25 °C	4.7K to 20K	Ω			
Tolerance on R ₂₅ -value	± 1; ± 2; ± 3; ± 5	%			
B _{25/85} -value	3435 to 3865	K			
Tolerance on B _{25/85} -value	± 1	%			
Operating temperature range	-55 to +175	°C			
Response time (63.2 %) 25 °C to 85 °C still air (for info)	3	S			
Dissipation factor δ in still air (for info, non-mounted die)	3	mW			
Maximum power dissipation	50	mW			
Weight	3	mg			

MOUNTING

The thermistors are primarily intended for wire bonding or sintering. Contact specifications (thickness material) and bonding parameters are available on request. The parameters of the assembly process should be chosen in accordance with the lead-wire material.

The mounting process should be in compliance with the following guidelines and recommendations:

Die bonding: reflow soldering under vacuum or with formic acid / forming gases, with SAC or HMP / silver epoxy gluing / nano silver paste sintering.

Cleaning:

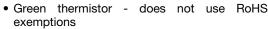
Detergent spraying

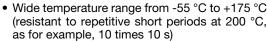
Revision: 17-Feb-2023

• Ultrasonic cleaning is allowed if limited in time to 5 minutes

FEATURES

 Flat chip contacted top and bottom (NTCC201E4 series)





- · Highly resistant to mounting conditions
- Ideal for aluminum wire
- Resistance to leaching during reflow soldering process
- Delivered on blister tape
- AEC-Q200 qualified
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- High temperature sensing, control and compensation in power semiconductor modules (e.g. IGBT, SiC MOSFET, Diodes, ...), inverters in EV/HEV vehicles, and windmills
- IC and semiconductor protecting
- DC/AC power inverters and HIC overheat protecting

DESIGN-IN SUPPORT

For complete curve computation, please visit: www.vishay.com/thermistors/ntc-curve-list/

MARKING

The thermistors have no marking and have electrode termination design without orientation.

Wire bonding:

 The silver electrode has been tested for aluminum wire bonding with a wire diameter of max. 300 µm

Encapsulation:

- In order to preserve the characteristics of the bonded die at long term an encapsulation is mandatory
- The encapsulation is defined by the user. Silicon and epoxy encapsulations have been tested. For recommendations on compatible encapsulants contact Vishay

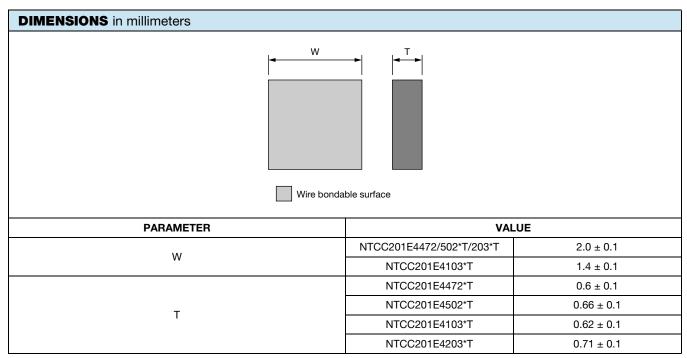
ELECTRICAL DATA AND ORDERING INFORMATION					
R ₂₅ (Ω)	R ₂₅ -TOL. (± %)	B _{25/85} (K)	B _{25/85} -TOL. (± %)	DESCRIPTION	SAP MATERIAL AND ORDERING NUMBER (1)
4700	1, 2, 3, 5	3435	1	Bare die with top / bottom silver terminations	NTCC201E4472*T
5000	1, 2, 3, 5	3435	1	Bare die with top / bottom silver terminations	NTCC201E4502*T
10 000	1, 2, 3, 5	3435	1	Bare die with top / bottom silver terminations	NTCC201E4103*T
20 000	1, 2, 3, 5	3865	1	Bare die with top / bottom silver terminations	NTCC201E4203*T

Note

(1) In order to define R_{25} -tolerance, replace * in SAP part number by F (\pm 1 %), G (\pm 2 %), H (\pm 3 %), or J (\pm 5 %)

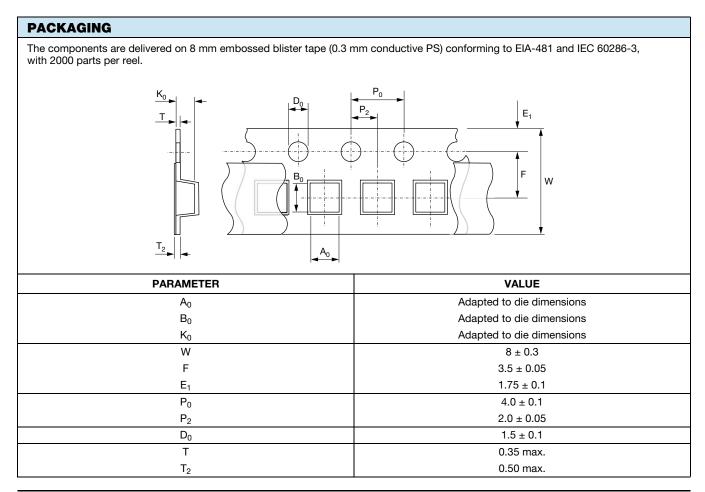


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Note

• Non-dimensioned details do not affect the performance of the thermistors





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